# **MOSFET** – Dual, N-Channel, Small Signal, ESD Protection, SC-88 20 V

### Features

- Small Footprint (2 x 2 mm)
- Low Gate Charge N-Channel Device
- ESD Protected Gate
- Same Package as SC-70 (6 Leads)
- AEC-Q101 Qualified and PPAP Capable NVJD4401N
- These Devices are Pb-Free and are RoHS Compliant

#### Applications

- Load Power Switching
- Li-Ion Battery Supplied Devices
- Cell Phones, Media Players, Digital Cameras, PDAs
- DC-DC Conversion

#### **MAXIMUM RATINGS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise stated)

Param	Symbol	Value	Unit			
Drain-to-Source Voltage	V <sub>DSS</sub>	20	V			
Gate-to-Source Voltage	)		V <sub>GS</sub>	±12	V	
Continuous Drain Current			Ι <sub>D</sub>	0.63	А	
(Based on $R_{\theta JA}$ )	State	T <sub>A</sub> = 85°C		0.46		
Power Dissipation	Steady	$T_A = 25^{\circ}C$	PD	0.27	W	
(Based on R <sub>θJA</sub> )	State	$T_A = 85^{\circ}C$		0.14		
Continuous Drain Current	Steady State	$T_A = 25^{\circ}C$	Ι <sub>D</sub>	0.91	А	
(Based on R <sub>θJL</sub> )	Sidle	T <sub>A</sub> = 85°C		0.65		
Power Dissipation	Steady	$T_A = 25^{\circ}C$		0.55	W	
(Based on R <sub>θJL</sub> )	State	$T_A = 85^{\circ}C$	PD	0.29		
Pulsed Drain Current	I <sub>DM</sub>	±1.2	А			
Operating Junction and	T <sub>J</sub> , T <sub>STG</sub>	–55 to 150	°C			
Continuous Source Curr	۱ <sub>S</sub>	0.63	А			
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C	

#### THERMAL RESISTANCE RATINGS (Note 1)

Parameter	Symbol	Тур	Max	Units
Junction-to-Ambient - Steady State	$R_{\thetaJA}$	400	458	°C/W
Junction-to-Lead (Drain) - Steady State	$R_{\theta JL}$	194	252	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

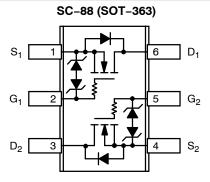
1. Surface mounted on FR4 board using 1 oz Cu area = 0.9523 in sq.



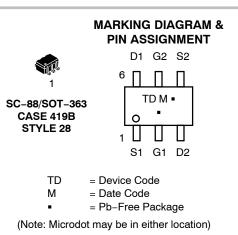
# **ON Semiconductor®**

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V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub> Typ	I <sub>D</sub> Max	
20 V -	0.29 Ω @ 4.5 V	0.63 A	
	0.36 Ω @ 2.5 V	0.03 A	



Top View



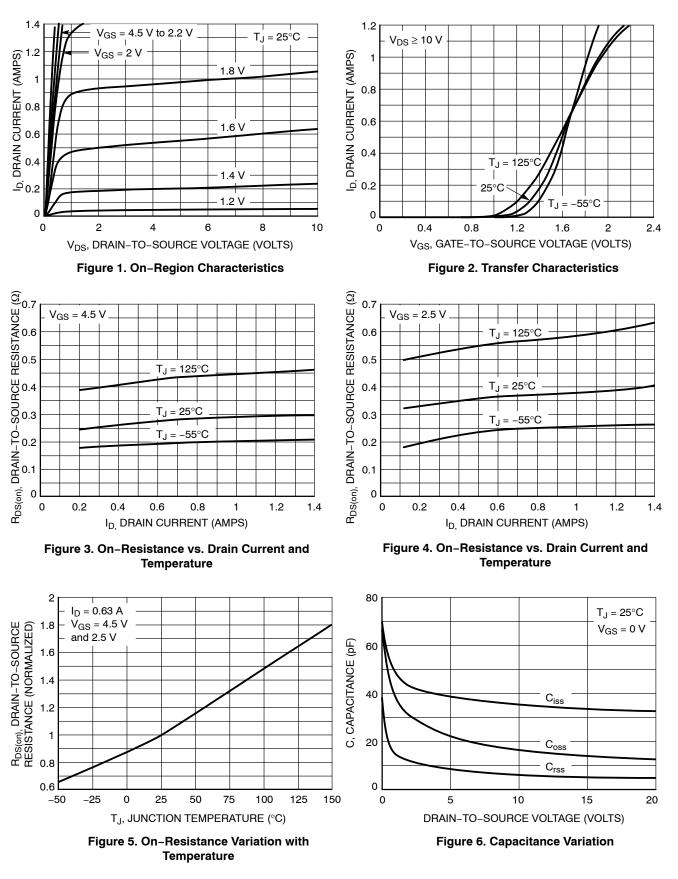
#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

## **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise stated)

Parameter	Symbol	Test Con	dition	Min	Тур	Max	Unit
OFF CHARACTERISTICS							•
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS} = 0 V, I_D$	= 250 μA	20	27		V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> /T <sub>J</sub>				22		mV/ °C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>GS</sub> = 0 V, V <sub>I</sub>	<sub>DS</sub> = 16 V			1.0	μΑ
Gate-to-Source Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>G</sub>	<sub>iS</sub> = ±12 V			10	μΑ
ON CHARACTERISTICS (Note 2)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	$V_{GS} = V_{DS}, I_{D}$	) = 250 μA	0.6	0.92	1.5	V
Gate Threshold Temperature Coefficient	V <sub>GS(TH)</sub> /T <sub>J</sub>				-2.1		mV/ °C
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V, I	<sub>D</sub> = 0.63 A		0.29	0.375	Ω
		V <sub>GS</sub> = 2.5 V, I	<sub>D</sub> = 0.40 A		0.36	0.445	
Forward Transconductance	<b>9</b> FS	V <sub>DS</sub> = 4.0 V, I	<sub>D</sub> = 0.63 A		2.0		S
CHARGES AND CAPACITANCES							
Input Capacitance	C <sub>ISS</sub>				33	46	pF
Output Capacitance	C <sub>OSS</sub>	V <sub>GS</sub> = 0 V, f = 1.0 MHz, V <sub>DS</sub> = 20 V			13	22	
Reverse Transfer Capacitance	C <sub>RSS</sub>				2.8	5.0	
Total Gate Charge	Q <sub>G(TOT)</sub>	$V_{GS}$ = 4.5 V, $V_{DS}$ = 10 V, I <sub>D</sub> = 0.63 A			1.3	3.0	nC
Threshold Gate Charge	Q <sub>G(TH)</sub>				0.1		
Gate-to-Source Charge	Q <sub>GS</sub>				0.2		
Gate-to-Drain Charge	Q <sub>GD</sub>		ſ		0.4		1
SWITCHING CHARACTERISTICS (No	ote 3)						
Turn-On Delay Time	td <sub>(ON)</sub>				0.083		μs
Rise Time	tr	V <sub>GS</sub> = 4.5 V, V	חם = 10 V,		0.227		
Turn–Off Delay Time	td <sub>(OFF)</sub>	$I_{\rm D} = 0.5 \text{ A}, \text{ R}_{\rm G} = 20 \Omega$			0.786		
Fall Time	tf				0.506		
DRAIN-SOURCE DIODE CHARACTE	RISTICS					•	
Forward Diode Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0 V,	$T_J = 25^{\circ}C$		0.76	1.1	V
		I <sub>S</sub> =0.23 A	T <sub>J</sub> = 125°C		0.63		
Reverse Recovery Time	t <sub>RR</sub>	V <sub>GS</sub> = 0 V, dI <sub>S</sub> /dt I <sub>S</sub> = 0.6			0.410		μs

Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.
Switching characteristics are independent of operating junction temperatures.



#### TYPICAL PERFORMANCE CURVES (T<sub>J</sub> = 25°C unless otherwise noted)

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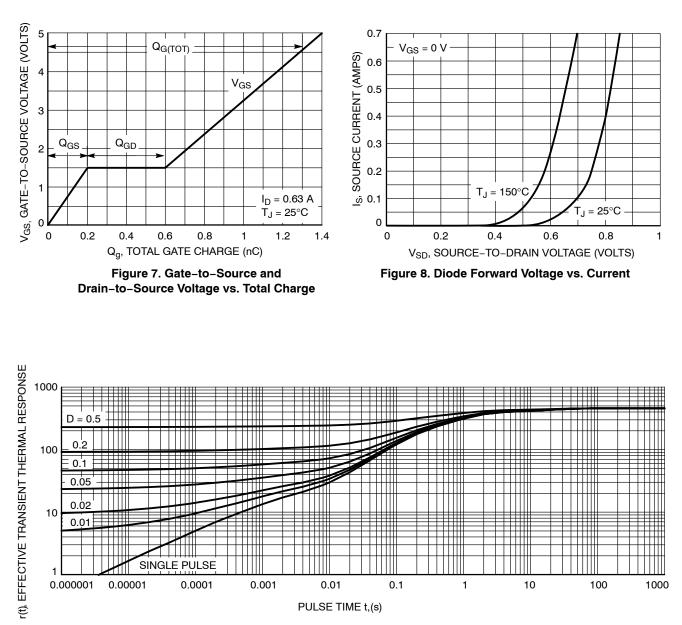


Figure 9. Thermal Response

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
NTJD4401NT1G	SC–88 (Pb–Free)	3000 / Tape & Reel
NVJD4401NT1G	SC-88 (Pb-Free)	3000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

0.043

0.004





- XXX = Specific Device Code

(Note: Microdot may be in either location)

\*Date Code orientation and/or position may vary depending upon manufacturing location.

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.



DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering

details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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#### DATE 11 DEC 2012

STYLE 1: PIN 1. EMITTER 2 2. BASE 2 3. COLLECTOR 1 4. EMITTER 1 5. BASE 1 6. COLLECTOR 2	STYLE 2: CANCELLED	STYLE 3: CANCELLED	STYLE 4: PIN 1. CATHODE 2. CATHODE 3. COLLECTOR 4. EMITTER 5. BASE 6. ANODE	STYLE 5: PIN 1. ANODE 2. ANODE 3. COLLECTOR 4. EMITTER 5. BASE 6. CATHODE	STYLE 6: PIN 1. ANODE 2 2. N/C 3. CATHODE 1 4. ANODE 1 5. N/C 6. CATHODE 2
STYLE 7: PIN 1. SOURCE 2 2. DRAIN 2 3. GATE 1 4. SOURCE 1 5. DRAIN 1 6. GATE 2	STYLE 8: CANCELLED	STYLE 9: PIN 1. EMITTER 2 2. EMITTER 1 3. COLLECTOR 1 4. BASE 1 5. BASE 2 6. COLLECTOR 2	STYLE 10: PIN 1. SOURCE 2 2. SOURCE 1 3. GATE 1 4. DRAIN 1 5. DRAIN 2 6. GATE 2	STYLE 11: PIN 1. CATHODE 2 2. CATHODE 2 3. ANODE 1 4. CATHODE 1 5. CATHODE 1 6. ANODE 2	STYLE 12: PIN 1. ANODE 2 2. ANODE 2 3. CATHODE 1 4. ANODE 1 5. ANODE 1 6. CATHODE 2
STYLE 13:	STYLE 14:	STYLE 15:	STYLE 16:	STYLE 17:	STYLE 18:
PIN 1. ANODE	PIN 1. VREF	PIN 1. ANODE 1	PIN 1. BASE 1	PIN 1. BASE 1	PIN 1. VIN1
2. N/C	2. GND	2. ANODE 2	2. EMITTER 2	2. EMITTER 1	2. VCC
3. COLLECTOR	3. GND	3. ANODE 3	3. COLLECTOR 2	3. COLLECTOR 2	3. VOUT2
4. EMITTER	4. IOUT	4. CATHODE 3	4. BASE 2	4. BASE 2	4. VIN2
5. BASE	5. VEN	5. CATHODE 2	5. EMITTER 1	5. EMITTER 2	5. GND
6. CATHODE	6. VCC	6. CATHODE 1	6. COLLECTOR 1	6. COLLECTOR 1	6. VOUT1
STYLE 19:	STYLE 20:	STYLE 21:	STYLE 22:	STYLE 23:	STYLE 24:
PIN 1. I OUT	PIN 1. COLLECTOR	PIN 1. ANODE 1	PIN 1. D1 (i)	PIN 1. Vn	PIN 1. CATHODE
2. GND	2. COLLECTOR	2. N/C	2. GND	2. CH1	2. ANODE
3. GND	3. BASE	3. ANODE 2	3. D2 (i)	3. Vp	3. CATHODE
4. V CC	4. EMITTER	4. CATHODE 2	4. D2 (c)	4. N/C	4. CATHODE
5. V EN	5. COLLECTOR	5. N/C	5. VBUS	5. CH2	5. CATHODE
6. V REF	6. COLLECTOR	6. CATHODE 1	6. D1 (c)	6. N/C	6. CATHODE
STYLE 25:	STYLE 26:	STYLE 27:	STYLE 28:	STYLE 29:	STYLE 30:
PIN 1. BASE 1	PIN 1. SOURCE 1	PIN 1. BASE 2	PIN 1. DRAIN	PIN 1. ANODE	PIN 1. SOURCE 1
2. CATHODE	2. GATE 1	2. BASE 1	2. DRAIN	2. ANODE	2. DRAIN 2
3. COLLECTOR 2	3. DRAIN 2	3. COLLECTOR 1	3. GATE	3. COLLECTOR	3. DRAIN 2
4. BASE 2	4. SOURCE 2	4. EMITTER 1	4. SOURCE	4. EMITTER	4. SOURCE 2
5. EMITTER	5. GATE 2	5. EMITTER 2	5. DRAIN	5. BASE/ANODE	5. GATE 1
6. COLLECTOR 1	6. DRAIN 1	6. COLLECTOR 2	6. DRAIN	6. CATHODE	6. DRAIN 1

Note: Please refer to datasheet for style callout. If style type is not called out in the datasheet refer to the device datasheet pinout or pin assignment.

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